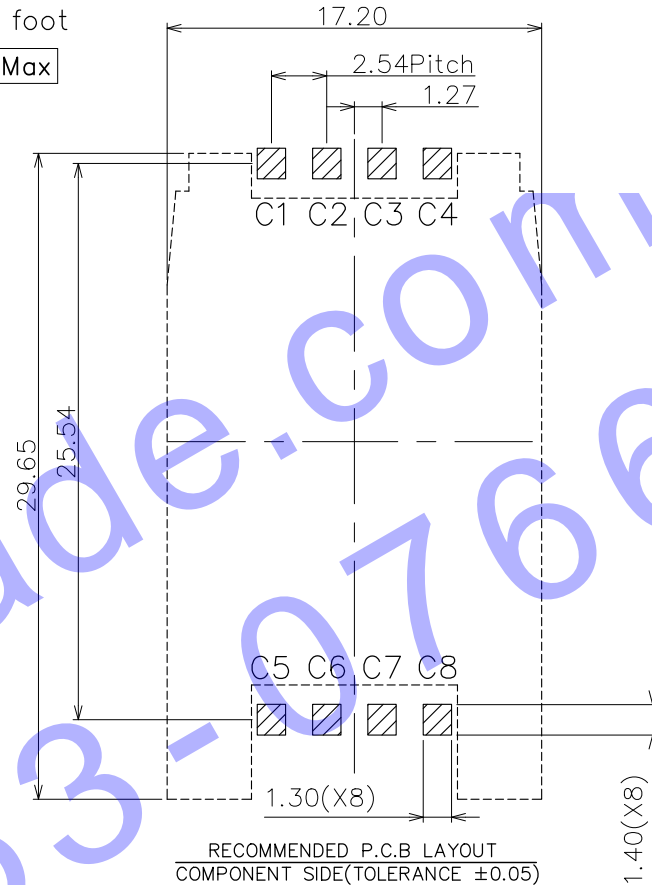
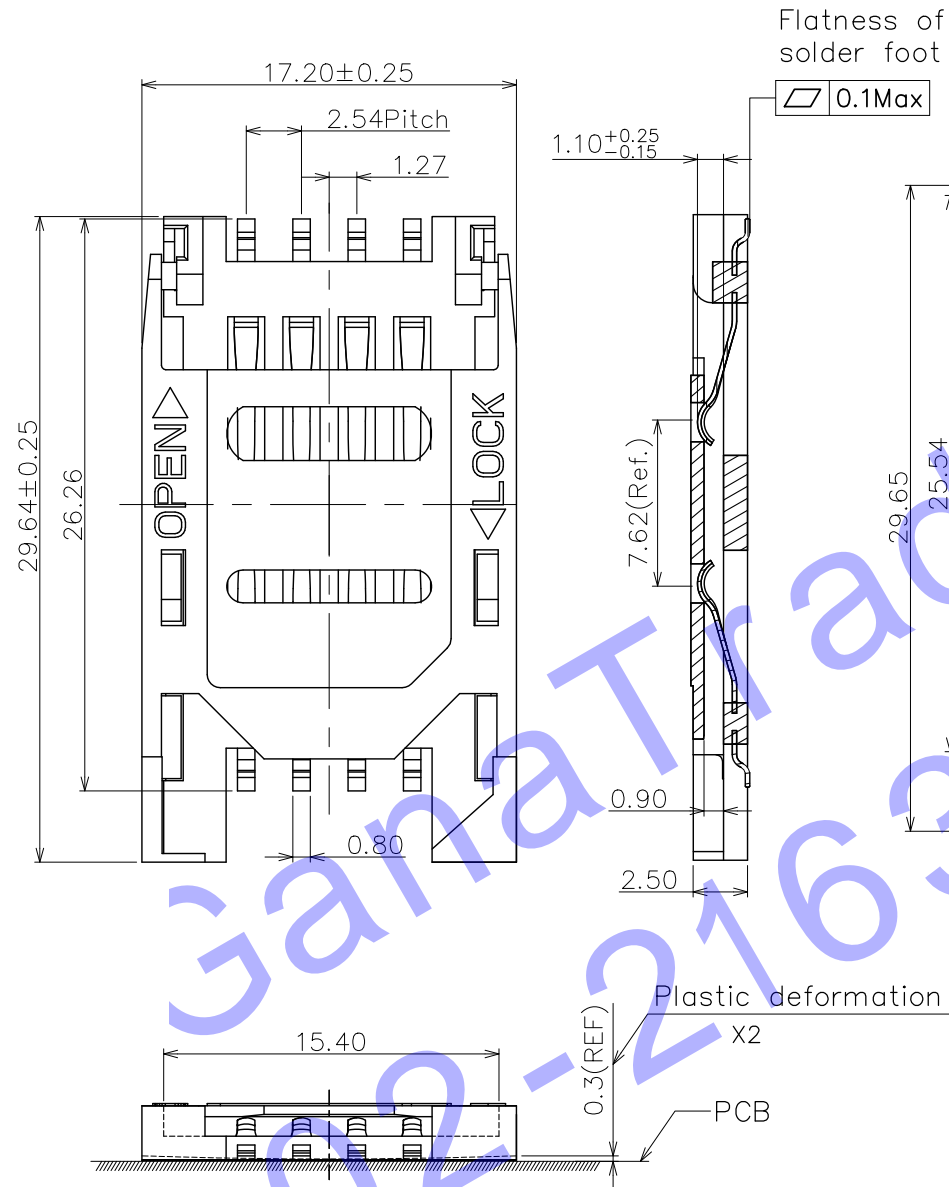
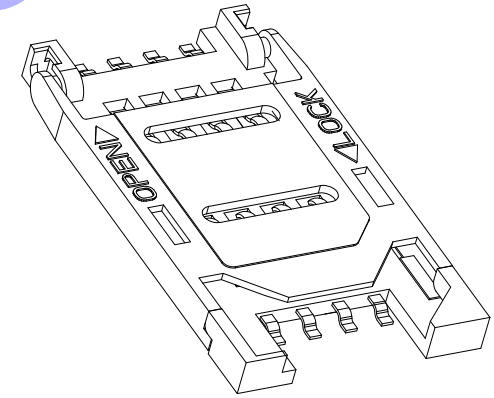


REV.	DESCRIPTION OF REVISIONS	APPR.	DRAW.	RELEASE	DATE
X1	新开	Simon	Jimmy	Lynn	2006.3.10
X2	增加主体塑性变形尺寸	Simon	huabo	Lynn	2020.9.17



- TECHNICAL CHARACTERISTICS**
- General Characteristics**
 Dimensions: 29.65LX17.20WX2.50H mm
 Weight: Approx.1.01g
 Durability: 5,000 cycles min.
 - Electrical Characteristics**
 Contact resistance: 50mΩ typical, 100mΩ max
 Insulation resistance: >1000MΩ/500V DC
 - Solderability**
 Vapor phase: 215°C, 30sec. Max
 IR reflow: 250°C, 5sec. Max
 Manual soldering: 370°C, 3sec. Max
 - Environmental Characteristics**
 Operating temperature: -40°C~+85°C
 Operating humidity: 10%~+95%RH



RECOMMENDED P.C.B LAYOUT
COMPONENT SIDE (TOLERANCE ±0.05)

ITEM	PART NAME	Q'TY	MATERIAL	FINISH
1	BASE	1	Hi-temp Thermoplastic	Black UL94V-0
2	COVER	1	Hi-temp Thermoplastic	Black UL94V-0
3	DATA CONTACT	8	Copper Alloy	Contact area: 5u" Au plated

Unless otherwise specified, other tolerance are:

X	±0.35	X'	±5'
X.X	±0.25	X.X'	±4'
X.XX	±0.15	X.XX'	±3'
X.XXX	±0.10	X.XXX'	±2'

H D C 有限公司

NAME: SIM Card Connector

MODEL NO: C713-6

TYPE: H2.5 without post 8p

PROJ.	UNIT	SCALE	DRAWN	Zoey Mar.10.2006	DWG NO.:
①	mm	1:1	CHECKED	Jimmy Mar.10.2006	DWG-C713-006
CUSTOMER DRAWING			APPROVAL	Simon Mar.10.2006	SHEET
					1/1
					REVISION
					X2

